2299056-1 - ACTIVE

TE Internal #: 2299056-1 SFP, SFP+ & zSFP+, Cage Assembly, Data Rate (Max) 16 Gb/s, Internal/External EMI Springs, SFP+, Not Optional, 1 x 1, Through Hole - Press-Fit, 1 Port

View on TE.com >



Connectors > Pluggable IO Connectors & Cages > SFP, SFP+ & zSFP+



Pluggable I/O Product Type: Cage Assembly

Data Rate (Max): 16 Gb/s

EMI Containment Feature Type: Internal/External EMI Springs

Pluggable I/O Applications: SFP+

Lightpipe Options: Not Optional

Features

Product Type Features

Form Factor	SFP+
Cage Туре	Single
Thermal Accessory Type Included	Heat Sink

Pluggable I/O Product Type	Cage Assembly		
Lightpipe Options	Not Optional		
Connector System	Cable-to-Board		
Sealable	No		
Connector & Contact Terminates To	Printed Circuit Board		
Configuration Features			
Port Matrix Configuration	1 x 1		
Number of Ports	1		
Electrical Characteristics			
Data Rate (Max)	16 Gb/s		
Body Features			
Heat Sink Finish	Electroless Nickel		
Heat Sink Height Class	Custom		
Heat Sink Height	3.5 mm[.137 in]		
Heat Sink Style	Slug		

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Termination Features

Termination Post & Tail Length	3 mm[.118 in]		
Termination Method to Printed Circuit Board	Through Hole - Press-Fit		
Mechanical Attachment			
Connector Mounting Type	Board Mount		
Housing Features			
Cage Material	Nickel Silver Alloy		
Dimensions			
PCB Thickness (Recommended)	1.5 mm[.059 in]		
Usage Conditions			
Operating Temperature Range	-55 – 105 °C[-67 – 221 °F]		
Operation/Application			
Heat Sink Compatible	Yes		
For Use With Pluggable I/O Products	SFP+ SMT Connector		
Pluggable I/O Applications	SFP+		
Circuit Application	Signal		

Packaging Features

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Packaging Method	Tray		
Other			
EMI Containment Feature Type	Internal/External EMI Springs		
Product Compliance For compliance documentation, visit the product page on TE.com>			
EU RoHS Directive 2011/65/EU	Compliant		
EU ELV Directive 2000/53/EC	Compliant		
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold		
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC		
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free		

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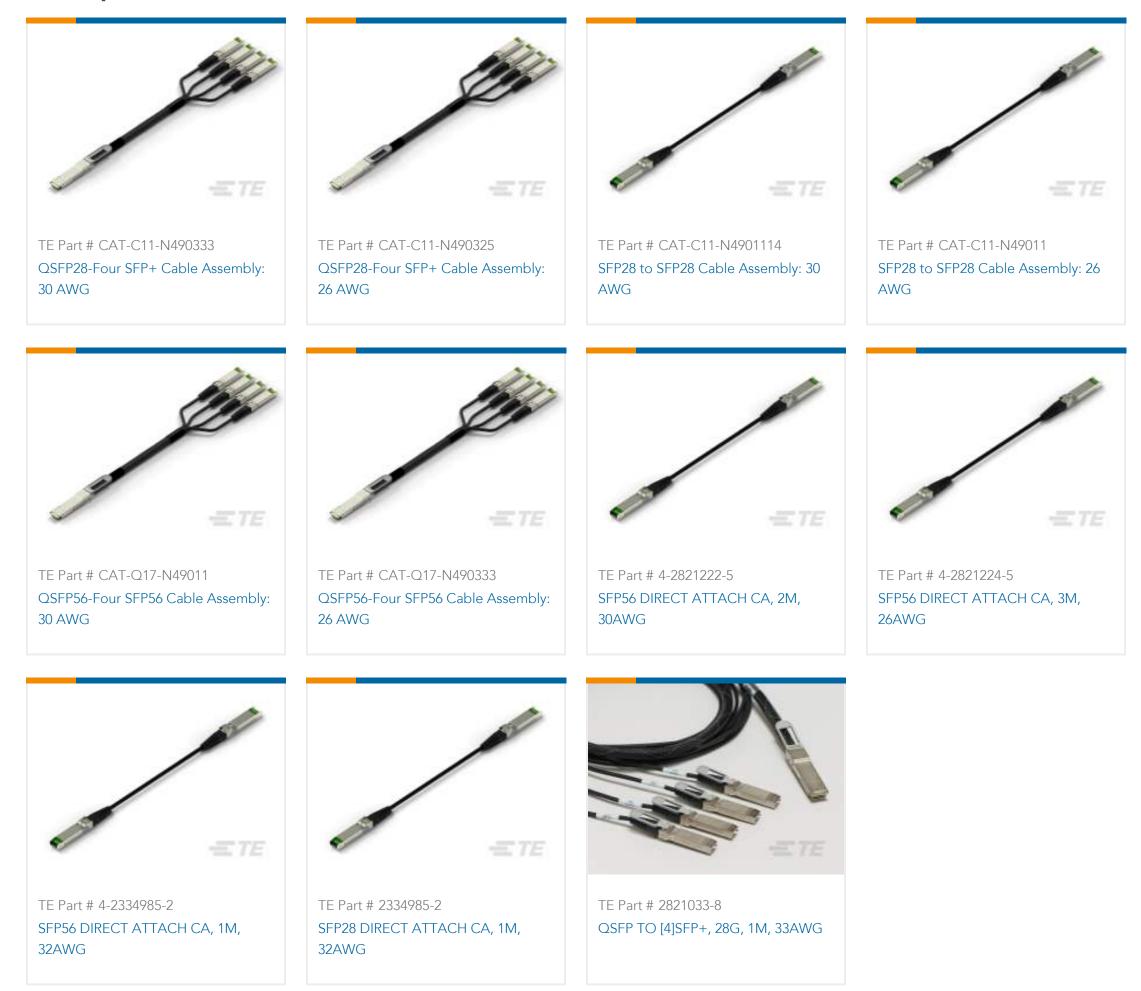
Solder Process Capability

Not applicable for solder process capability

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

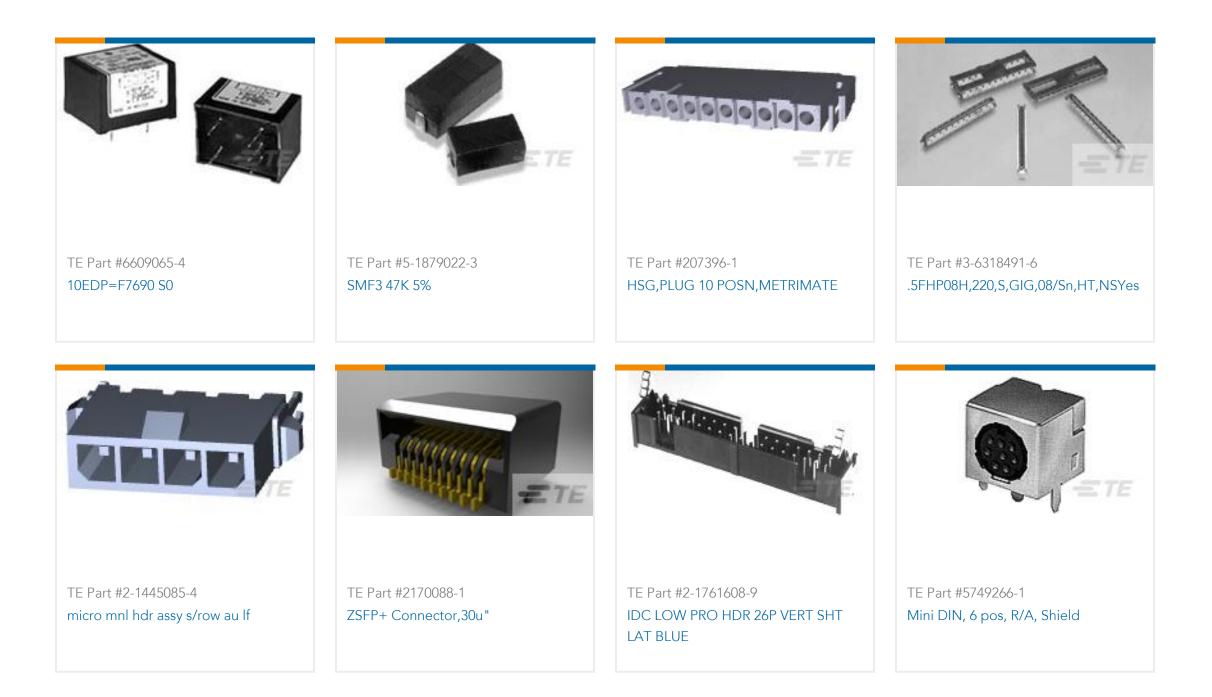
Compatible Parts



Customers Also Bought

SFP, SFP+ & zSFP+, Cage Assembly, Data Rate (Max) 16 Gb/s, Internal/External EMI Springs, SFP+, Not Optional, 1 x 1, Through Hole - Press-Fit, 1 Port





Documents

Product Drawings SFP+ 1X1 CAGE ASSEMBLY AND CONN, PRESS-F

English

CAD Files

3D PDF

3D

Customer View Model ENG_CVM_CVM_2299056-1_A.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_2299056-1_A.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_2299056-1_A.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Product Specifications Product Specification

English

Product Environmental Compliance Product Compliance English

Product Compliance

English

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